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PC725V0NSZX/ PC725V0YSZX

Features

- 1. TTL compatible output
- 2. High collector-emitter voltage (VCEO:300V)
- 3. High sensitivity (CTR:MIN. 1 000%)
- 4. Isolation voltage (Viso (rms):5kV)
- 5. Recognized by UL, file No.E64380
 - Approved by TÜV (VDE0884)(PC725V0YSZX)
- 6. 6-pin DIP package

Applications

- 1. Home appliances
- 2. Programmable controllers
- 3. Peripheral equipment of personal computers

Model Line-up

Model No.	* Safty St Appr	tandard roval	Package	Packing	
	UL	TÜV (VDE0884)	U		
PC725V0NSZX	0	-	DIP	Sleeve	
PC725V0YSZX	0	0	DIP		

* Application Model No. PC725V

Absolute Maximum Ratings

ings (Ta=25°C)

			•	
	Parameter	Symbol	Rating	Unit
	Forward current	IF	50	mA
Input	*1 Peak forward current	Ifm	1	Α
mput	Reverse voltage	Vr	6	V
	Power dissipation	Р	70	mW
	Collector-emitter voltage	VCEO	300	V
	Collector-base voltage	Vсво	300	V
Output	Emitter-base voltage	Vebo	6	V
Output	Collector current	Ic	150	mA
	Collector current (reverse)	-Ic	10	mA
	Collector power dissipation	Pc	300	mW
	Total power dissipation	Ptot	350	mW
	*2 Isolation voltage		5	kV
Operating temperature		Topr	-25 to +100	°C
	Storage temperature	Tstg	-40 to +125	°C
	*3 Soldering temperature	Tsol	260	°C

*1 Pulse width≤100µs, Duty ratio=0.001

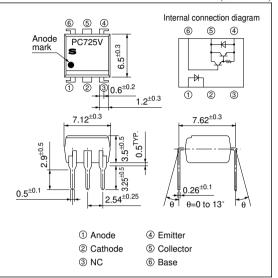
*2 40 to 60%RH, AC for 1 min

*3 For 10 s

High Sensitivity and High Collector-emitter Voltage Type Photocoupler

Outline Dimensions

(Unit : mm)



Electro	o-optical Charac	teristics					(Ta=25°C)
	Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
	Forward voltage		VF	IF=10mA	-	1.2	1.4	V
Input	Peak forward voltage	:	VFM	Іғм=0.5А	-	-	3	V
mput	Reverse current		Ir	V _R =4V	-	-	10	μΑ
	Terminal capacitance		Ct	V=0, f=1kHz	-	30	250	pF
Output	Collector dark current		ICEO	Vce=200V, IF=0, RBE=∞	-	-	10-6	Α
	Collector current		Ic	IF=1mA, VCE=2V, RBE=∞	10	40	150	mA
	Collector-emitter saturation voltage		VCE(sat)	IF=20mA, Ic=100mA, R _{BE} =∞		-	1.2	V
Transfer	Isolation resistance		Riso	DC500V, 40 to 60%RH	5×1010	1011	-	Ω
charac-	Floating capacitance		Cf	V=0, f=1MHz	-	0.6	1.0	pF
teristics	Cut-off frequency		fc	Vce=2V, Ic=20mA, RL=100Ω, RBE=∞, -3dB	1	7	-	kHz
	Rise time	tr	VCE=2V, IC=20mA	_	100	300	μs	
	Response time Fall time		tr	RL=100 Ω , RBE= ∞	_	20	100	μs

Fig.1 Forward Current vs. Ambient Temperature

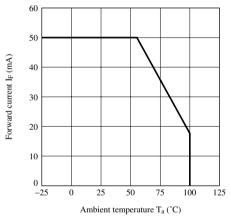


Fig.3 Peak Forward Current vs. Duty Ratio

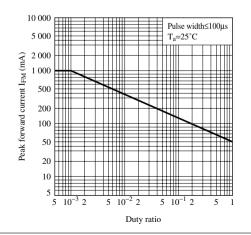


Fig.2 Collector Power Dissipation vs. Ambient Temperature

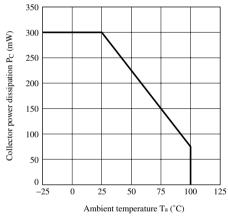


Fig.4 Forward Current vs. Forward Voltage

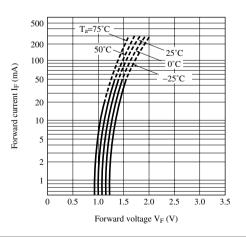
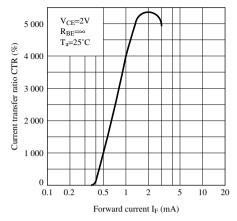
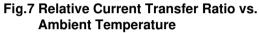
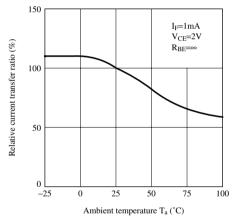


Fig.5 Current Transfer Ratio vs. Forward Current









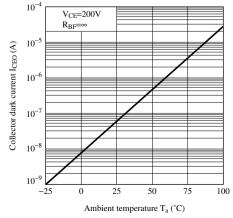


Fig.6 Collector Current vs. Collector-emitter Voltage

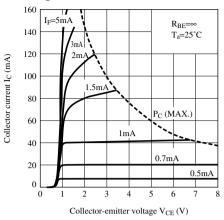


Fig.8 Collector - emitter Saturation Voltage vs. Ambient Temperature

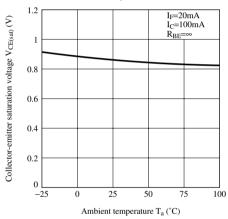


Fig.10 Response Time vs. Load Resistance

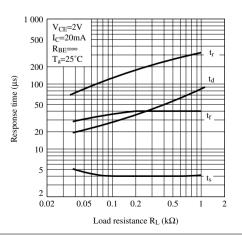
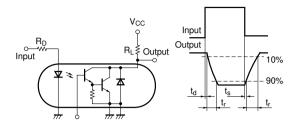
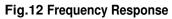


Fig.11 Test Circuit for Response Time





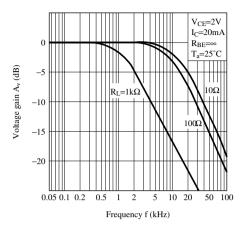
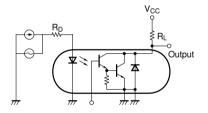


Fig.13 Test Circuit for Frequency Response



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- •Observe the following points when using any devices in this publication. SHARP takes no responsibility for damage caused by improper use of the devices which does not meet the conditions and absolute maximum ratings to be used specified in the relevant specification sheet nor meet the following conditions:
 - (i) The devices in this publication are designed for use in general electronic equipment designs such as:
 - Personal computers
 - Office automation equipment
 - Telecommunication equipment [terminal]
 - Test and measurement equipment
 - Industrial control
 - Audio visual equipment
 - Consumer electronics

(ii)Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection with equipment that requires higher reliability such as:

- Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
- Traffic signals
- Gas leakage sensor breakers
- Alarm equipment
- Various safety devices, etc.

(iii)SHARP devices shall not be used for or in connection with equipment that requires an extremely high level of reliability and safety such as:

- Space applications
- Telecommunication equipment [trunk lines]
- Nuclear power control equipment
- Medical and other life support equipment (e.g., scuba).
- •Contact a SHARP representative in advance when intending to use SHARP devices for any "specific" applications other than those recommended by SHARP or when it is unclear which category mentioned above controls the intended use.
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PC725V0NIZX/ PC725V0NIPX

Features

- 1. TTL compatible output
- 2. High collector-emitter voltage (VCEO:300V)
- 3. High sensitivity (CTR:MIN. 1 000%)
- 4. Isolation voltage (Viso (rms):5kV)
- 5. Recognized by UL, file No.E64380
- 6. 6-pin DIP package (Lead forming type)

Applications

- 1. Home appliances
- 2. Programmable controllers
- 3. Peripheral equipment of personal computers

Model Line-up

Model No.	* Safty St App	tandard roval	Package	Packing	
	UL	TÜV (VDE0884)			
PC725V0NIZX	0	-	Surface	Sleeve	
PC725V0NIPX	0	-	Mount	Taping	

* Application Model No. PC725V

Absolute Maximum Ratings

■ Absolute Maximum Ratings (Ta=25°C)							
	Parameter	Symbol	Rating	Unit			
Input	Forward current	IF	50	mA			
	*1 Peak forward current	Ifm	1	А			
	Reverse voltage	Vr	6	V			
	Power dissipation	Р	mbol Rating Unit iF 50 mA iF 50 mA iM 1 A iM 6 V image: State in the image in the	mW			
Output	Collector-emitter voltage	VCEO	300	V			
	Collector-base voltage	Vсво	300	V			
	Emitter-base voltage	Vebo	6	V			
	Collector current	Ic	150	mA			
	Collector current (reverse)	-Ic	10	mA			
	Collector power dissipation	Pc	300	mW			
	Total power dissipation	Ptot	350	mW			
*2 Isolation voltage		Viso (rms)	5	kV			
	Operating temperature		-25 to +100	°C			
	Storage temperature	Tstg	-40 to +125	°C			
	*3 Soldering temperature	Tsol	260	°C			

*1 Pulse width≤100µs, Duty ratio=0.001

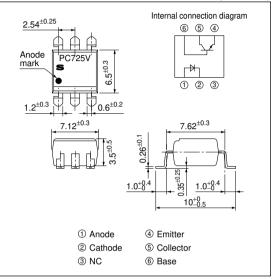
*2 40 to 60%RH. AC for 1 min

*3 For 10 s

High Sensitivity and High Collector-emitter Voltage Type Photocoupler

Outline Dimensions

(Unit : mm)



In the absence of confirmation by device specification sheets, SHARP takes no responsibility for any defects that may occur in equipment using any SHARP devices shown in catalogs, data books, etc. Contact SHARP in order to obtain the latest device specification sheets before using any SHARP device. Internet address for Electronic Components Group http://www.sharp.co.jp/edg/ Notice Internet

■ Electro	o-optical Charac	teristics					(Ta=25°C)
	Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
	Forward voltage		VF	IF=10mA	-	1.2	1.4	V
Input	Peak forward voltage	:	VFM	IFM=0.5A	-	-	3	V
mput	Reverse current		Ir	V _R =4V	-	-	10	μΑ
	Terminal capacitance		Ct	V=0, f=1kHz	-	30	250	pF
Output	Collector dark current		ICEO	Vce=200V, IF=0, RBE=∞	-	-	10-6	Α
	Collector current		Ic	IF=1mA, VCE=2V, RBE=∞	10	40	150	mA
	Collector-emitter saturation voltage		VCE(sat)	IF=20mA, Ic=100mA, R _{BE} =∞	-	_	1.2	V
Transfer	Isolation resistance		Riso	DC500V, 40 to 60%RH	5×1010	1011	-	Ω
charac-	Floating capacitance		Cf	V=0, f=1MHz	-	0.6	1.0	pF
teristics	Cut-off frequency		fc	Vce=2V, Ic=20mA, RL=100Ω, RBE=∞, -3dB	1	7	-	kHz
	Rise time	tr	VCE=2V, IC=20mA	-	100	300	μs	
	Response time Fall time		tr	RL=100 Ω , RBE= ∞	_	20	100	μs

Fig.1 Forward Current vs. Ambient Temperature

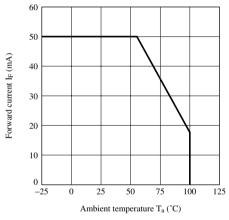


Fig.3 Peak Forward Current vs. Duty Ratio

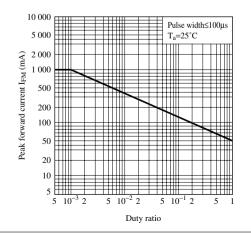


Fig.2 Collector Power Dissipation vs. Ambient Temperature

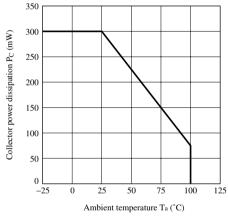


Fig.4 Forward Current vs. Forward Voltage

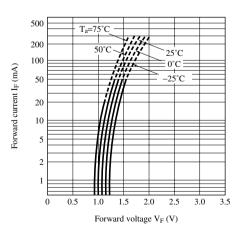
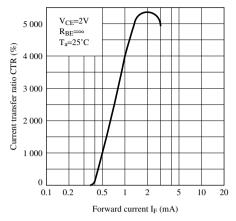
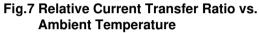
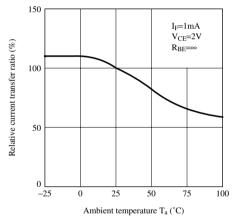


Fig.5 Current Transfer Ratio vs. Forward Current









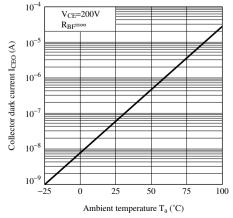


Fig.6 Collector Current vs. Collector-emitter Voltage

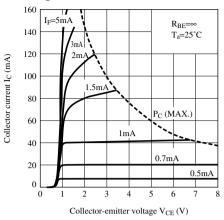


Fig.8 Collector - emitter Saturation Voltage vs. Ambient Temperature

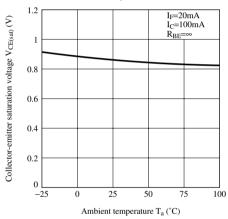


Fig.10 Response Time vs. Load Resistance

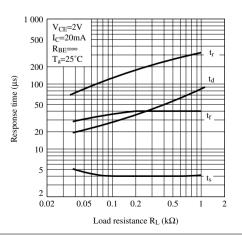
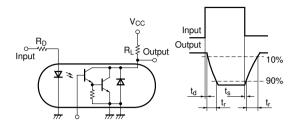
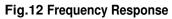


Fig.11 Test Circuit for Response Time





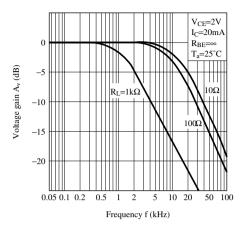
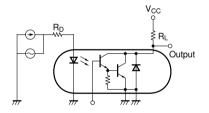


Fig.13 Test Circuit for Frequency Response



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PC725V0YUZX

Features

- 1. TTL compatible output
- 2. High collector-emitter voltage (VCEO:300V)
- 3. High sensitivity (CTR:MIN. 1 000%)
- 4. Isolation voltage (Viso (rms):5kV)
- 5. Recognized by UL, file No.E64380 Approved by TÜV (VDE0884)
- 6. 6-pin DIP package (Lead forming type)
- 7. Sleeve packing

Applications

- 1. Home appliances
- 2. Programmable controllers
- 3. Peripheral equipment of personal computers

Absolute Maximum Ratings (Ta=25°C) Parameter Symbol Rating Unit Forward current \mathbf{I}_{F} 50 mА *1 Peak forward current IEM 1

Input	¹ Peak forward current	IFM	1	A
mput	Reverse voltage	VR	6	V
	Power dissipation	Р	70	mW
	Collector-emitter voltage	VCEO	300	V
	Collector-base voltage	Vсво	300	V
Output	Emitter-base voltage	Vebo	6	V
Output	Collector current	or current Ic 150 r	mA	
	Collector current (reverse)	-Ic	10	mA
	Collector power dissipation	Pc	300	mW
	Total power dissipation	Ptot	350	mW
	*2 Isolation voltage		5	kV
Operating temperature		Topr	-25 to +100	°C
	Storage temperature	Tstg	-40 to +125	°C
	*3 Soldering temperature	Tsol	260	°C

*1 Pulse width≤100µs, Duty ratio=0.001

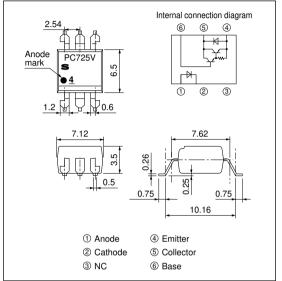
*2 40 to 60%RH. AC for 1 min

*3 For 10 s

High Sensitivity and High Collector-emitter Voltage Type Photocoupler

Outline Dimensions

(Unit : mm)



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Electro	o-optical Charac	teristics					(Ta=25°C)
	Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
	Forward voltage		VF	IF=10mA	-	1.2	1.4	V
Input	Peak forward voltage		VFM	Іғм=0.5А	-	-	3	V
mput	Reverse current		Ir	V _R =4V	-	-	10	μΑ
	Terminal capacitance		Ct	V=0, f=1kHz	-	30	250	pF
Output	Collector dark current		Iceo	V _{CE} =200V, IF=0, R _{BE} =∞	-	-	10-6	Α
	Collector current		Ic	IF=1mA, VCE=2V, RBE=∞	10	40	150	mA
	Collector-emitter saturation voltage		VCE(sat)	IF=20mA, Ic=100mA, R _{BE} =∞	-	-	1.2	V
Transfer	Isolation resistance		Riso	DC500V, 40 to 60%RH	5×1010	1011	-	Ω
charac-	Floating capacitance		Cf	V=0, f=1MHz	-	0.6	1.0	pF
teristics	Cut-off frequency		fc	Vce=2V, Ic=20mA, RL=100Ω, RBE=∞, -3dB	1	7	-	kHz
	Desmanas time	Rise time	tr	VCE=2V, IC=20mA	-	100	300	μs
	Response time Fall time		tr	R _L =100Ω, R _{BE} =∞	-	20	100	μs

Fig.1 Forward Current vs. Ambient Temperature

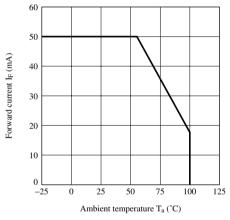


Fig.3 Peak Forward Current vs. Duty Ratio

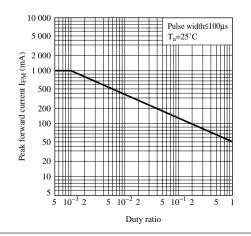


Fig.2 Collector Power Dissipation vs. Ambient Temperature

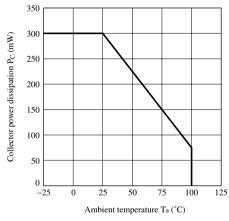


Fig.4 Forward Current vs. Forward Voltage

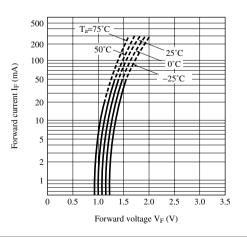
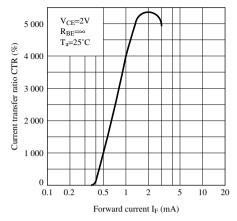
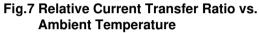
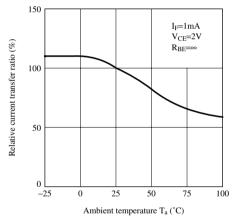


Fig.5 Current Transfer Ratio vs. Forward Current









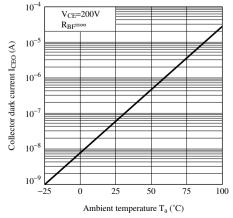


Fig.6 Collector Current vs. Collector-emitter Voltage

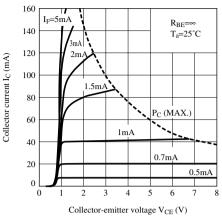


Fig.8 Collector - emitter Saturation Voltage vs. Ambient Temperature

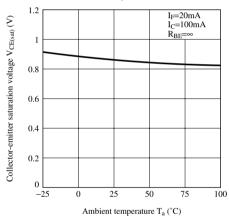


Fig.10 Response Time vs. Load Resistance

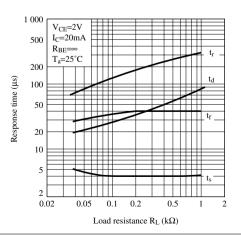
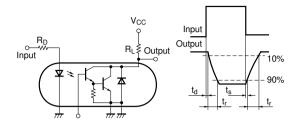
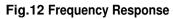


Fig.11 Test Circuit for Response Time





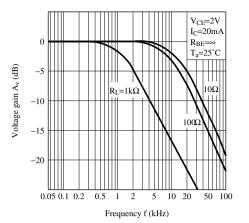
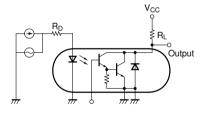


Fig.13 Test Circuit for Frequency Response



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